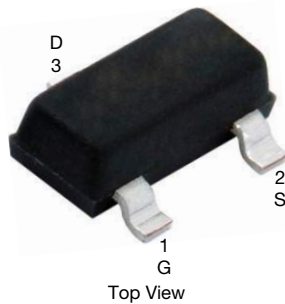


Automotive N-Channel 60 V (D-S) 175 °C MOSFET

SOT-23 (TO-236)



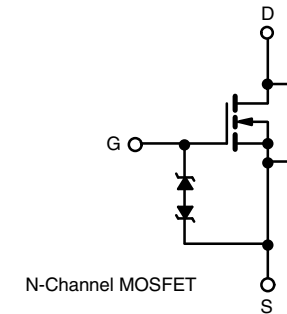
Top View

Marking code: 9Jxxx

FEATURES

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % Rg and UIS tested
- Typical ESD protection 800 V
- Material categorization:
for definitions of compliance please see www.vishay.com/doc?99912

 AUTOMOTIVE
GRADE

RoHS
COMPLIANT
HALOGEN
FREE


N-Channel MOSFET

| PRODUCT SUMMARY | |
|---|--------|
| V_{DS} (V) | 60 |
| $R_{DS(on)}$ (Ω) at $V_{GS} = 1.5$ V | 0.245 |
| I_D (A) | 2 |
| Configuration | Single |
| Package | SOT-23 |

| ORDERING INFORMATION | |
|---------------------------------|--|
| Package | SOT-23 |
| Lead (Pb)-free and halogen-free | SQ2364EES-T1 (for detailed order number please see www.vishay.com/doc?79771) |

| ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C, unless otherwise noted) | | | | |
|---|----------------|----------------|------|---|
| PARAMETER | SYMBOL | LIMIT | UNIT | |
| Drain-source voltage | V_{DS} | 60 | V | |
| Gate-source voltage | V_{GS} | ± 8 | | |
| Continuous drain current | I_D | $T_C = 25$ °C | 2 | A |
| | | $T_C = 125$ °C | 1.3 | |
| Continuous source current (diode conduction) | I_S | 2 | | |
| Pulsed drain current ^a | I_{DM} | 8 | | |
| Single pulse avalanche current | I_{AS} | 5 | 1.25 | |
| Single pulse avalanche energy | | | | |
| Maximum power dissipation ^a | P_D | $T_C = 25$ °C | 3 | W |
| | | $T_C = 125$ °C | 1 | |
| Operating junction and storage temperature range | T_J, T_{stg} | -55 to +175 | °C | |

| THERMAL RESISTANCE RATINGS | | | | |
|----------------------------|------------|-------|------|--|
| PARAMETER | SYMBOL | LIMIT | UNIT | |
| Junction-to-ambient | R_{thJA} | 166 | °C/W | |
| Junction-to-foot (drain) | | | | |

Notes

- Pulse test; pulse width ≤ 300 μ s, duty cycle ≤ 2 %
- When mounted on 1" square PCB (FR4 material)



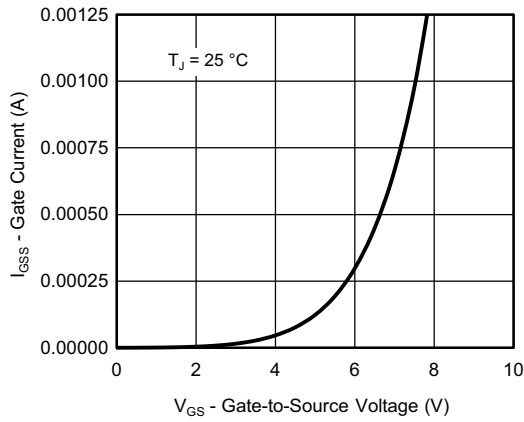
| SPECIFICATIONS ($T_C = 25\text{ }^\circ\text{C}$, unless otherwise noted) | | | | | | | |
|---|--------------|--|---|------|-------|-----------|---------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNIT |
| Static | | | | | | | |
| Drain-source breakdown voltage | V_{DS} | $V_{GS} = 0, I_D = 250\text{ }\mu\text{A}$ | | 60 | - | - | V |
| Gate-source threshold voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$ | | 0.46 | 0.6 | 1 | |
| Gate-source leakage | I_{GSS} | $V_{DS} = 0\text{ V}, V_{GS} = \pm 3\text{ V}$ | | - | - | ± 100 | nA |
| | | $V_{DS} = 0\text{ V}, V_{GS} = \pm 8\text{ V}$ | | - | - | ± 5.5 | |
| Zero gate voltage drain current | I_{DSS} | $V_{GS} = 0\text{ V}$ | $V_{DS} = 60\text{ V}$ | - | - | 1 | μA |
| | | $V_{GS} = 0\text{ V}$ | $V_{DS} = 60\text{ V}, T_J = 125\text{ }^\circ\text{C}$ | - | - | 50 | |
| | | $V_{GS} = 0\text{ V}$ | $V_{DS} = 60\text{ V}, T_J = 175\text{ }^\circ\text{C}$ | - | - | 150 | |
| On-state drain current ^a | $I_{D(on)}$ | $V_{GS} = 4.5\text{ V}$ | $V_{DS} \geq 5\text{ V}$ | 2 | - | - | A |
| Drain-source on-state resistance ^a | $R_{DS(on)}$ | $V_{GS} = 4.5\text{ V}$ | $I_D = 2\text{ A}, T_J = 25\text{ }^\circ\text{C}$ | - | 0.190 | 0.240 | Ω |
| | | $V_{GS} = 4.5\text{ V}$ | $I_D = 2\text{ A}, T_J = 125\text{ }^\circ\text{C}$ | - | - | 0.460 | |
| | | $V_{GS} = 4.5\text{ V}$ | $I_D = 2\text{ A}, T_J = 175\text{ }^\circ\text{C}$ | - | - | 0.600 | |
| | | $V_{GS} = 1.5\text{ V}$ | $I_D = 2\text{ A}$ | - | 0.195 | 0.245 | |
| Forward transconductance ^b | g_{fs} | $V_{DS} = -15\text{ V}, I_D = 1\text{ A}$ | | - | 8.8 | - | S |
| Dynamic ^b | | | | | | | |
| Input capacitance | C_{iss} | $V_{GS} = 0\text{ V}$ | $V_{DS} = 25\text{ V}, f = 1\text{ MHz}$ | - | 263 | 330 | pF |
| Output capacitance | C_{oss} | | | - | 28 | 35 | |
| Reverse transfer capacitance | C_{rss} | | | - | 15 | 19 | |
| Total gate charge ^c | Q_g | $V_{GS} = 4.5\text{ V}$ | $V_{DS} = 30\text{ V}, I_D = 1.5\text{ A}$ | - | 2 | 2.5 | nC |
| Gate-source charge ^c | Q_{gs} | | | - | 0.3 | - | |
| Gate-drain charge ^c | Q_{gd} | | | - | 0.6 | - | |
| Gate resistance | R_g | $f = 1\text{ MHz}$ | | 2.5 | 4.1 | 6.6 | Ω |
| Turn-on delay time ^c | $t_{d(on)}$ | $V_{DD} = 30\text{ V}, R_L = 15\text{ }\Omega$ $I_D \cong 1.5\text{ A}, V_{GEN} = 10\text{ V}, R_g = 1\text{ }\Omega$ | | - | 6 | 7.2 | ns |
| Rise time ^c | t_r | | | - | 11 | 14 | |
| Turn-off delay time ^c | $t_{d(off)}$ | | | - | 26 | 32 | |
| Fall time ^c | t_f | | | - | 13 | 16 | |
| Source-Drain Diode Ratings and Characteristics ^b | | | | | | | |
| Pulsed current ^a | I_{SM} | | | - | - | 8 | A |
| Forward voltage | V_{SD} | $I_F = 2\text{ A}, V_{GS} = 0$ | | - | 0.8 | 1.2 | V |

Notes

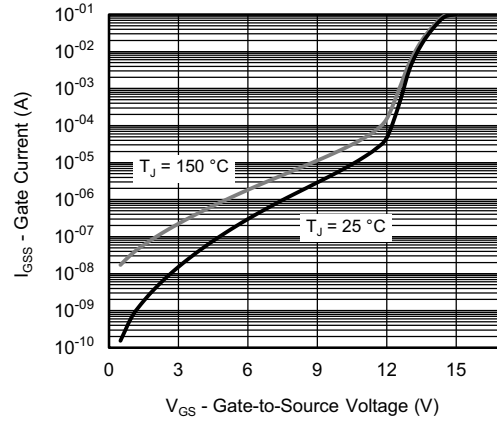
- Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$
- Guaranteed by design, not subject to production testing
- Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

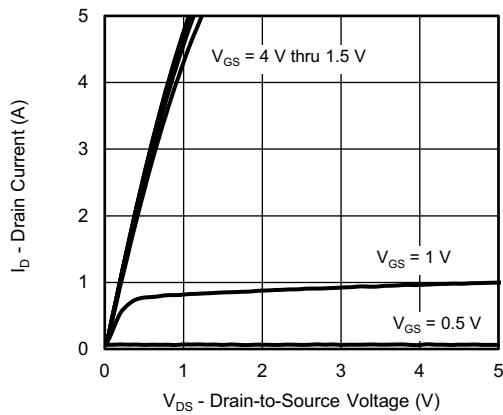
TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted)



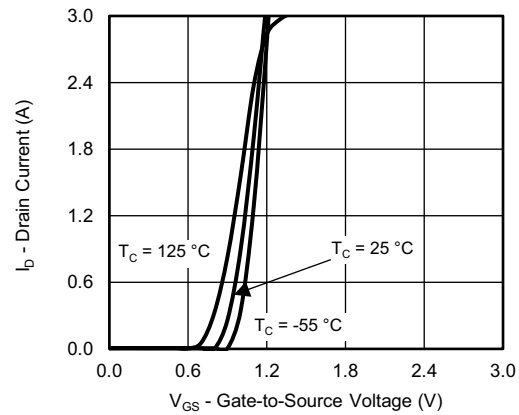
Gate Current vs. Gate-Source Voltage



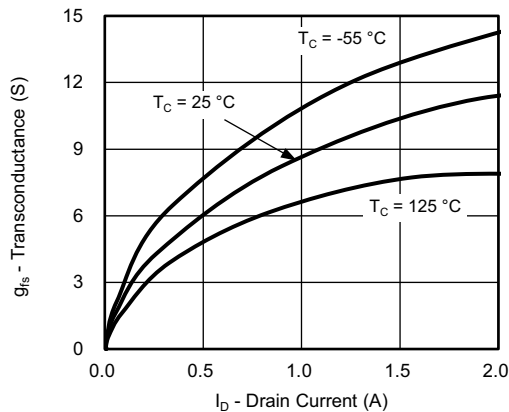
Gate Current vs. Gate-Source Voltage



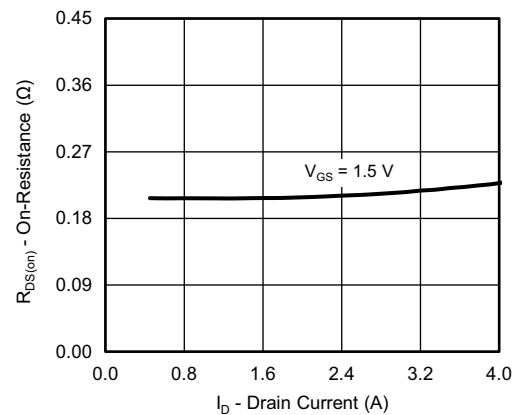
Output Characteristics



Transfer Characteristics

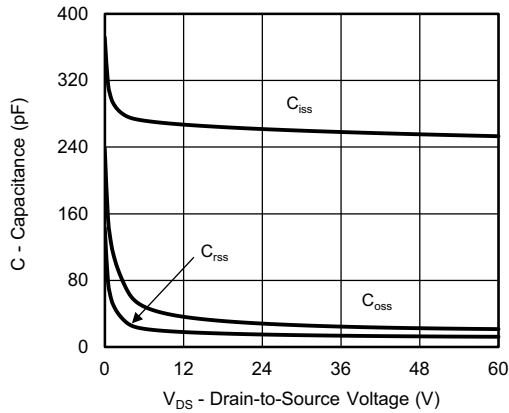


Transconductance

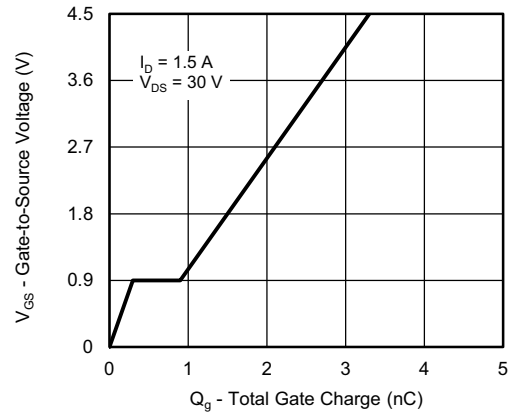


On-Resistance vs. Drain Current

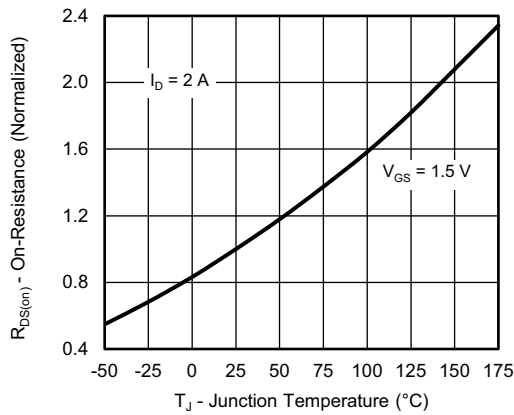
TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted)



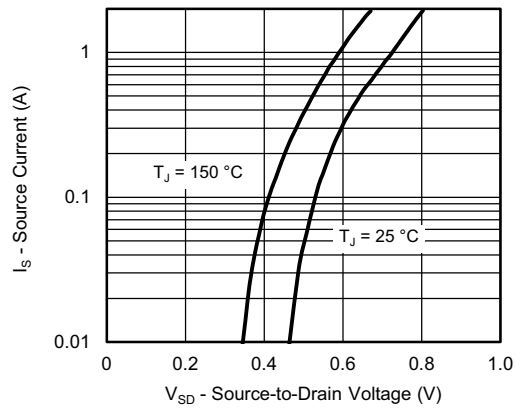
Capacitance



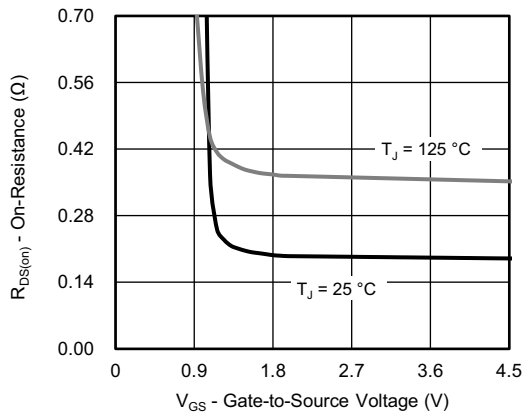
Gate Charge



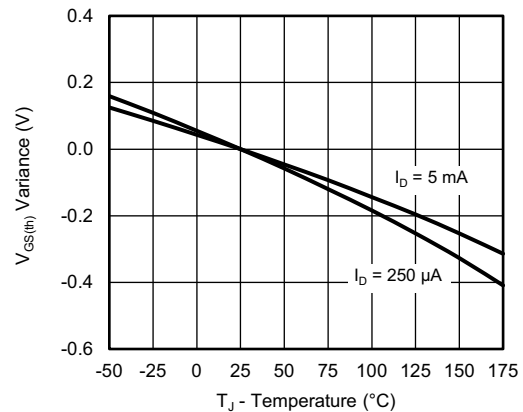
On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage



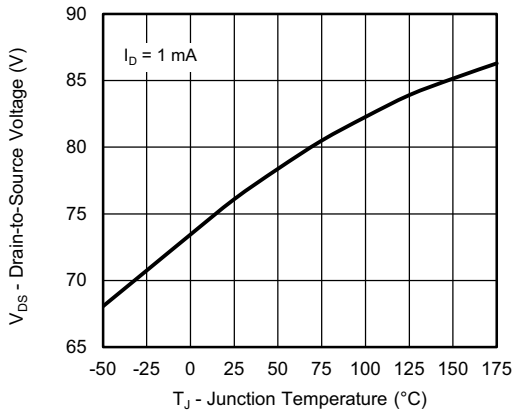
On-Resistance vs. Gate-Source Voltage



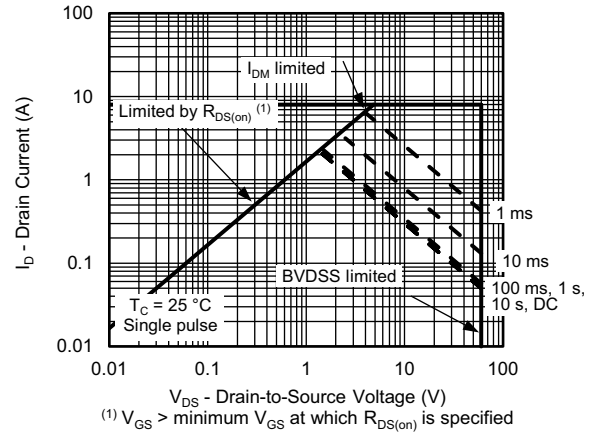
Threshold Voltage



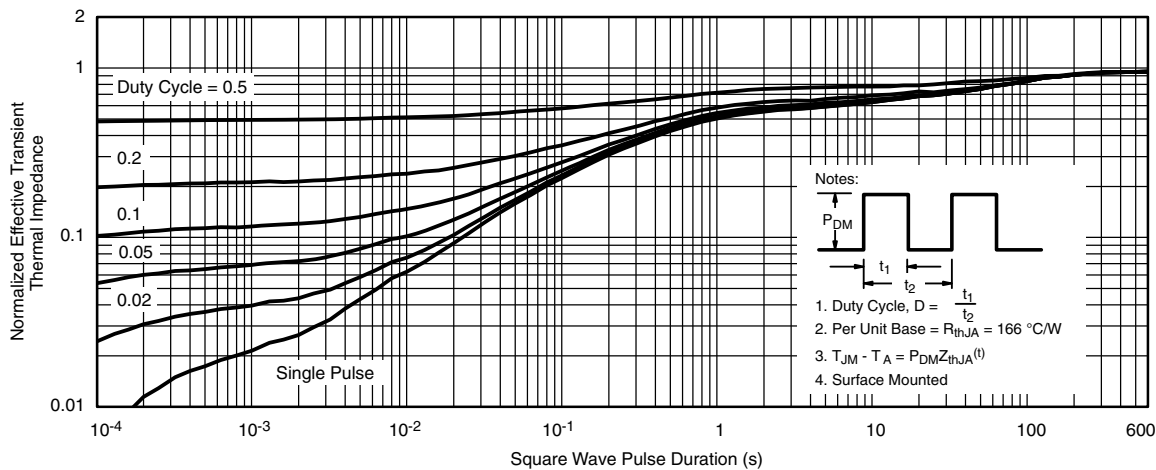
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Drain-Source Breakdown vs. Junction Temperature



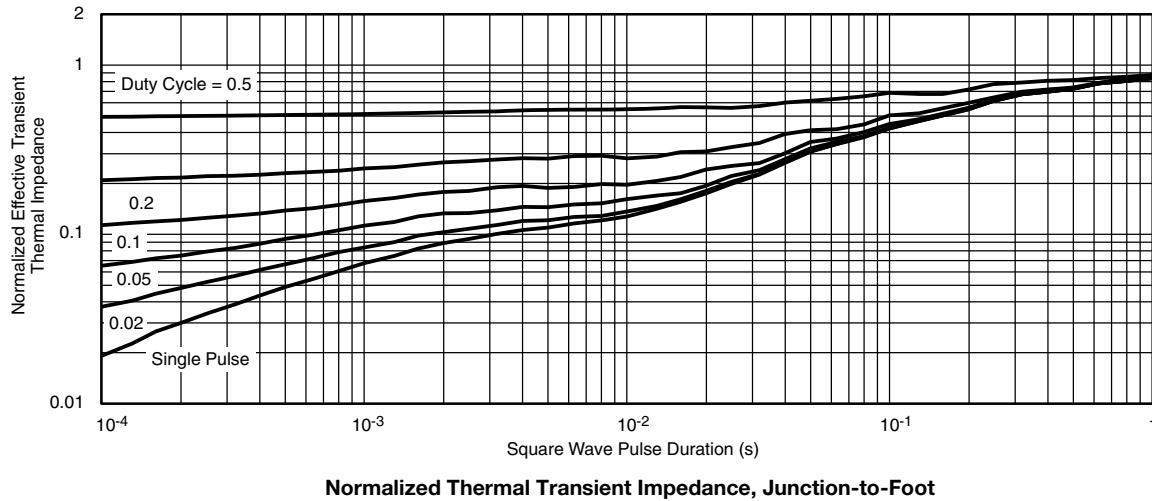
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS ($T_A = 25\text{ }^\circ\text{C}$, unless otherwise noted)



Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Foot (25 °C)
 are given for general guidelines only to enable the user to get a “ball park” indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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SOT-23 (TO-236): 3-LEAD



| Dim | MILLIMETERS | | INCHES | |
|----------------|-------------|------|------------|-------|
| | Min | Max | Min | Max |
| A | 0.89 | 1.12 | 0.035 | 0.044 |
| A ₁ | 0.01 | 0.10 | 0.0004 | 0.004 |
| A ₂ | 0.88 | 1.02 | 0.0346 | 0.040 |
| b | 0.35 | 0.50 | 0.014 | 0.020 |
| c | 0.085 | 0.18 | 0.003 | 0.007 |
| D | 2.80 | 3.04 | 0.110 | 0.120 |
| E | 2.10 | 2.64 | 0.083 | 0.104 |
| E ₁ | 1.20 | 1.40 | 0.047 | 0.055 |
| e | 0.95 BSC | | 0.0374 Ref | |
| e ₁ | 1.90 BSC | | 0.0748 Ref | |
| L | 0.40 | 0.60 | 0.016 | 0.024 |
| L ₁ | 0.64 Ref | | 0.025 Ref | |
| S | 0.50 Ref | | 0.020 Ref | |
| q | 3° | 8° | 3° | 8° |

ECN: S-03946-Rev. K, 09-Jul-01
 DWG: 5479

RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads
Dimensions in Inches/(mm)

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